

INVITATION FOR SPONSORSHIP



ISOCC 2023

20th International SoC Design Conference

October 25(Wed.)~28(Sat.), 2023

Ramada Plaza Jeju Hotel, Jeju, Korea



WELCOME MESSAGE

For over two decades, ISOCC has been a premier global forum for researchers in academia, industry, and institutes to showcase the latest innovations and trends in the semiconductor system-on-a-chip area. With a focus on presenting new advanced concepts and developments in analog and digital circuit and system design, theory, simulation, modeling, experimental implementations and experiences, and emerging technologies, ISOCC continues to be the leading conference in this field.

The 20th International SoC Conference (ISOCC 2023) will be held from October 25 to 28, 2023 at the Ramada Plaza Jeju Hotel in Jeju Island, Korea. Jeju Island is a stunning location, recognized as a national biosphere conservation area in 2002, a World Natural Heritage in 2007, and a 2010 World Geological Park Certification. It is the only area in the world that has achieved all three designations. Moreover, Jeju Island is rich in diverse natural landscapes, including islands, volcanoes, waterfalls, beaches, national parks, caves, and forests.

ISOCC 2023 is financially co-sponsored by IEEE CAS Society. All accepted papers will be published in the conference proceedings and will be submitted for inclusion in IEEE Xplore. We also welcome proposals for tutorials and special sessions. We hope you will join us at ISOCC 2023 for engaging discussions, insightful presentations, and memorable experiences. We look forward to seeing you in Jeju Island.

Minjae Lee

General Chair, ISOCC 2023
Professor, Gwangju Institute of Science and Technology



CONFERENCE OVERVIEW

Title 20th International SoC Design Conference (ISOCC 2023)

Theme Innovating the Future: Advancements in SoC and Emerging Technologies

Dates October 25 (Wed.) - 28 (Sat.), 2023

Venue Ramada Plaza Jeju Hotel, Jeju, Korea

Hosted by The Institute of Semiconductor Engineers

Financial Sponsor by IEEE Circuits and Systems Society

Expected No. of Papers Approx. 100 Oral Papers, 60 Poster Papers

Expected No. of Participants Approx. 500 participants from 15 countries

Official Language English

Official Website www.isocc.org

ISOCC 2023 SECRETARIAT

#1736, Dukmyung B/D, 625, Teheran-ro, Gangnam-gu, Seoul, 06173, South Korea

Tel: +82-2-757-0981

Email: secretary@isocc.org

INTRODUCTION

ISOCC has established a long tradition as an annual conference providing the premier SoC design forum for worldwide researchers from academia and industries. Since its inception, ISOCC has been continuing to showcase the most recent innovations and trends in the semiconductor system-on-a-chip area with active participations from worldwide researchers in academia, industry, and institutes. ISOCC 2023 welcomes technical papers in the field of semiconductor circuits and systems presenting new advanced concept and developments in analog and digital circuit and system design, theory, simulation, modeling, experimental implementations and experiences, and emerging technologies in the system-on-a-chip area.

HISTORY

No.	Conference	Venue
1 st	ISOCC 2004	COEX Conference Center, Seoul, Korea
2 nd	ISOCC 2005	COEX Conference Center, Seoul, Korea
3 rd	ISOCC 2006	COEX Conference Center, Seoul, Korea
4 th	ISOCC 2007	COEX Conference Center, Seoul, Korea
5 th	ISOCC 2008	BEXCO Convention Hall, Busan, Korea
6 th	ISOCC 2009	BEXCO Convention Hall, Busan, Korea
7 th	ISOCC 2010	Songdo Convensia, Incheon, Korea
8 th	ISOCC 2011	Ramada Plaza Jeju Hotel, Jeju, Korea
9 th	ISOCC 2012	Ramada Plaza Jeju Hotel, Jeju, Korea
10 th	ISOCC 2013	BEXCO Convention Hall, Busan, Korea
11 th	ISOCC 2014	Ramada Plaza Jeju Hotel, Jeju, Korea
12 th	ISOCC 2015	Hotel Hyundai, Gyeongju, Korea
13 th	ISOCC 2016	Ramada Plaza Jeju Hotel, Jeju, Korea
14 th	ISOCC 2017	Grand Hilton Seoul, Seoul, Korea
15 th	ISOCC 2018	Inter-Burgo Hotel Daegu, Daegu, Korea
16 th	ISOCC 2019	Ramada Plaza Jeju Hotel, Jeju, Korea
17 th	ISOCC 2020	Sono Calm Yeosu Hotel, Yeosu, Korea
18 th	ISOCC 2021	Ramada Plaza Jeju Hotel, Jeju, Korea
19 th	ISOCC 2022	Lakai Sandpine Resort, Gangwon-do, Korea



PRELIMINARY PROGRAM SCHEDULE

	October 25 (Wed.)	October 26 (Thurs.)	October 27 (Fri.)	October 28 (Sat.)
Morning	-	* Registration Opening Ceremony Keynote Speech	Registration Keynote Speech *	Discussion
Afternoon	Registration Tutorials	Chip Design Contest Parallel Sessions Short Tutorial Industrial Exhibition	WiSoC Parallel Sessions Short Tutorial Industrial Exhibition	-
Evening	Welcome Reception	Banquet	Closing Ceremony	-

*This is NOT the final program. The program is subject to change.

TOPICS OF INTEREST

*Topics include, but are not limited to:

- Analog Circuits
- Data Converters
- RF/Microwave/Wireless
- Wireline
- Digital Circuits, Architecture, and Systems
- Machine Learning and AI
- SoC Design Methodology and CAD
- Circuits and Systems for Emerging Technologies

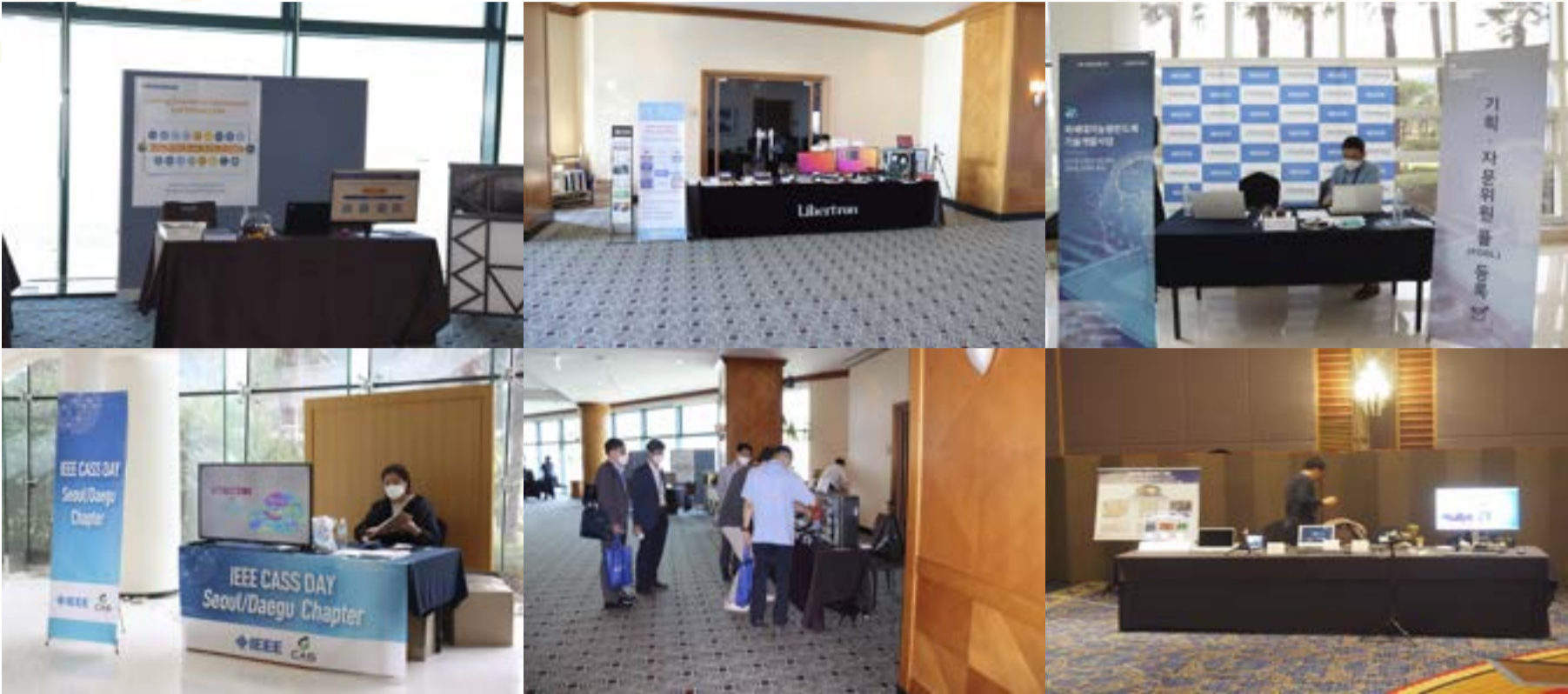
SPONSORSHIP PACKAGES

Level and Benefits	Diamond	Platinum	Gold	Silver	Bronze	Honor
	KRW 15,000,000	KRW 10,000,000	KRW 5,000,000	KRW 3,000,000	KRW 2,000,000	KRW 1,000,000
Advertising on Program Book (A5 Size, Color)	○ Back Cover (First Come, first served)	○ Inside the Back Cover (First Come, first served)	○	○	○	○
Advertising on Proceeding (A4 Size, PDF, Color)	○	○	○	○	○	○
Logo(CI) on Homepage	○	○	○	○	○	○
Exhibition Table Provided (a table, a chair, a backboard)	○	○	○ *	○	○	○
Free Registration	15 persons *	10 persons	5 persons	3 persons	2 persons	1 person
Write the name of the sponsor in each session in the program book	5 sessions	4 sessions	3 sessions *	2 sessions	1 session	×
Best Paper Award in the Name of the Sponsor	○	○	○	○	×	×
Logo on Proceeding USB	○	○	○	×	×	×
Logo on Name Badge	○	○	×	×	×	×

PLEASE NOTE

- *All advertisements and logos except for the back cover (out, in) are written in alphabetical order within the same grade.
- *Advertisement and logo (CI) files must be sent as illustration (AI) files or files with a resolution of 300dpi or higher.
- *The ad sizes are as follows:
 - Program Book: 148mm wide x 210mm high (A5 size)
 - Proceeding: 210mm wide x 297 mm high (A4 size)
- *The Sponsorship Packages are subject to change.

SPONSORED EXHIBITION EXAMPLES



APPLICATION GUIDELINE

1) Application Information

- Submit the completed application form along with the business license to the ISOCC 2023 secretariat office via e-mail (secretary@isocc.org).
- The applicant is responsible for any bank service charge or money transfer fees.
- Total amount of sponsorship fee is subject to change by the organizing committee.
- As for the allocation of sponsors and exhibition table locations, priority will be based first on the sponsorship grade, then the deposit payment date, and lastly the application date.

2) Contact Information

ISOCC 2023 SECRETARIAT

#1736, Dukmyung B/D, 625, Teheran-ro, Gangnam-gu, Seoul, 06173, South Korea

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APPLICATION FORM

1) Registering Company and Person in Charge

Company Name			
Contact Person Name			
Department		Job Title	
Address			
Telephone			
E-mail		Homepage	

2) Application

Category	Amount (KRW)	Check for your choice
Diamond	KRW 15,000,000~	
Platinum	KRW 10,000,000~	
Gold	KRW 5,000,000~	
Silver	KRW 3,000,000~	
Bronze	KRW 2,000,000~	
Honor	KRW 1,000,000~	

Date

Name

(Signature)
